Decrease in electrical contact resistance of Sb-doped n+-BaSi2 layers and spectral response of an Sb-doped n+-BaSi2/undoped BaSi2 structure for solar cells

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Decrease in electrical contact resistance of Sb-doped n^+-$BaSi_2$ layers and spectral response of an Sb-doped n^+-$BaSi_2$/undoped $BaSi_2$ structure for solar cells

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We investigated how the electron concentration n in a 300-nm-thick Sb-doped n^+-$BaSi_2$ layer grown by molecular beam epitaxy affected the contact resistance R_C to surface electrodes (Al, indium-tin-oxide). As the n of n-$BaSi_2$ increased, R_C decreased and reached a minimum of 0.019 Ω cm^2 at $n = 2.4 \times 10^{18}$ cm^{-3} for the Al electrodes. This value was more than one order of magnitude smaller than that obtained for Al/B-doped p-$BaSi_2$. We believe that this significant decrease in R_C came from Sb segregation. Furthermore, the internal quantum efficiency (*IQE*) spectrum was evaluated for an Sb-doped n^+-$BaSi_2$(20 nm)/undoped $BaSi_2$(500 nm)/n^+-Si(111) structure. Its *IQE* reached as high as ~50% over a wide wavelength range under a small bias voltage of 0.1 V applied between the top and bottom electrodes.

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1. Introduction

In many studies, various solar cells materials such as CdTe, chalcopyrites, kesterite, and perovskite have been assessed because of their low cost and high efficiency [1-6]. However, these materials contain elements that are scarce, toxic, or both. Thin-film Si solar cells have also been studied extensively; however, it is not easy to achieve efficiencies as high as 20% [7-17]. Thus, it is important to explore other materials for thin-film solar cells. Among such materials, we have focused on barium disilicide ($BaSi_2$), a semiconductor consisting of only abundant elements [18,19]. $BaSi_2$ is attractive for use in thin-film solar cells because of its bandgap of 1.3 eV, a matching solar spectrum [20], a high absorption coefficient of 3×10^4 cm^{-1} at 1.5 eV comparable to those of chalcopyrites [21-23], and superior minority-carrier diffusion length (L ~ 10 μm) [24,25] and lifetime (τ ~ 10 μs) [26-29]. Because of these properties, an energy conversion efficiency η of over 25% can be expected for a 2-μm-thick $BaSi_2$ pn-junction diode [30]. Recently, we have achieved a conversion efficiency near 10% with B-doped p-$BaSi_2$/n-Si heterojunction solar cells [31].

To fabricate $BaSi_2$ homojunction solar cells, we plan to use undoped $BaSi_2$ as an absorber layer in a solar cell. Undoped $BaSi_2$ has both a high α and a large L, both of which facilitate the collection of photogenerated carriers in an external circuit even though L degrades somewhat because of extrinsic effects such as crystal imperfections. In a solar cell, the topmost layer should be a heavily impurity-doped n- or p-type layer to decrease the contact resistance R_C, which directly affects the fill factor FF of the solar cell. As R_C increases, FF decreases and thus η decreases. In many studies, R_C have been assessed in solar cell materials [32-38]. In our previous work, we investigated the R_C between Al electrodes and B-doped p-$BaSi_2$. The R_C reached a minimum of 0.35 Ω cm^2 [31] when the hole concentration p of p-$BaSi_2$ was 4.0×10^{18} cm^{-3}. In this study, we first investigated the dependence of R_C between surface electrodes (Al or ITO) and Sb-doped n-$BaSi_2$ layers at various electron concentrations. We then evaluated the

spectral response of an Sb-doped n^+-$BaSi_2$(20 nm)/undoped $BaSi_2$(500 nm) structure to verify how the heavily doped n^+-$BaSi_2$ surface layer affected the spectral response, especially at short wavelengths.

2. Experimental methods

Here, we used an ion-pumped molecular beam epitaxy (MBE) system equipped with an electron-beam evaporation source for Si as well as standard Knudsen cells for Ba and Sb. Details of the growth procedure of undoped $BaSi_2$ and Sb-doped n-$BaSi_2$ were reported previously [39,40]. To measure R_C, we used high-resistivity Czochralski (CZ) p-Si(111) substrates (resistivity ρ = 1000–10000 Ω cm) to minimize current flowing through the substrate. After thermally cleaning the substrate at the substrate temperature T_S = 900 °C, we deposited Ba at 500 °C to form an approximately 5-nm-thick $BaSi_2$ template layer by reactive deposition epitaxy. This template worked as seeds that control the crystal orientation of the $BaSi_2$ overlayers [41]. Next, we formed 300-nm-thick Sb-doped n-$BaSi_2$ epitaxial layers by MBE at various T_S values of 460 (sample A), 480 (sample B), 500 (sample C), and 520 °C (sample D). The electron concentration n of Sb-doped n-$BaSi_2$ depends on T_S [40]. Then, a 3-nm-thick a-Si passivation layer was deposited *in situ* at T_S = 180 °C [42]. Finally, 150-nm-thick striped Al or ITO electrodes (length l = 0.6 mm, width W = 7.0 mm, electrode interval d = 1.0 mm) were formed by sputtering. Carrier concentration was measured by the van der Pauw method at room temperature (RT). R_C was measured by the transfer length method at RT [43]. We compared the smallest R_C, R_C = 0.35 Ω cm^2, measured from Al/p-$BaSi_2$ ($p = 4.0 \times 10^{18}$ cm^{-3}, sample E) [31]. The depth profile of Sb atoms was measured by secondary ion mass spectrometry (SIMS) using Cs^+ ions.

Next, we investigated the photoresponse properties of the Sb-doped n^+-$BaSi_2$/undoped $BaSi_2$ structure (sample F). A 500-nm-thick undoped $BaSi_2$ layer was epitaxially grown on a

low-resistivity Cz n-Si(111) substrate (ρ < 0.01 Ω cm) at T_S = 580 °C, followed by a 20-nm-thick Sb-doped n^+-$BaSi_2$ (n = 2.4 × 10^{18} cm^{-3}) layer and a 3-nm-thick a-Si passivation layer. We used the low-resistivity Si substrate to exclude the contribution of photogenerated carriers in the n-Si substrate and to form a good electrical contact at the $BaSi_2$/Si heterointerface. Finally, 80-nm-thick ITO electrodes with a diameter of 1 mm and 150-nm-thick Al rear electrodes were formed by sputtering. The reflectance R and external quantum efficiency (EQE) spectra were evaluated at RT using a lock-in technique with a xenon lamp and a single monochromator (Bunko Keiki, SM-1700A and RU-60N) with a focal length of 25 cm. Internal quantum efficiency (IQE) was obtained by dividing the EQE by (1−R). Light intensity was calibrated using a pyroelectric sensor (Melles Griot, 13PEM001/J). The crystalline quality of the grown layers was characterized by reflection high-energy electron diffraction (RHEED) and X-ray diffraction (XRD) analyses using Cu Kα radiation.

3. Results and discussion

Figure 1 shows the θ–2θ XRD and RHEED patterns of samples A, B, C, and D. The RHEED patterns were observed along the Si [$1\bar{1}2$] azimuth. The diffraction peaks appeared only from the (100)-oriented $BaSi_2$ planes, such as (200), (400), and (600), showing that a-axis-oriented $BaSi_2$ epitaxial films were formed. However, the RHEED patterns were not streaky but spotty, meaning that the surface is rough. This surface roughness developed because the T_S for Sb-doped $BaSi_2$ was much lower [40] than the optimum T_S (~600 °C) for the undoped $BaSi_2$ absorber layers. The n values of samples A, B, C, and D were 6.9 × 10^{17}, 1.8 × 10^{18}, 2.4 × 10^{18}, and 2.8 × 10^{17} cm^{-3}, respectively. Now, using sample C as an example, we will show how to obtain R_C. Figure 2 shows the relationship between the measured resistance $r(x)$ between the Al or ITO electrodes and the electrode distance x for sample C (n = 2.4 × 10^{18} cm^{-3}, μ = 100 cm^2/V s). Ignoring the lateral resistance of the electrode when the current flows in the x direction,

$r(x)$ can be written as

$$r(x) \approx 2r_c + r_{\text{semi}}(x), \quad (1)$$

where $r_{\text{semi}}(x)$ is the resistance of the semiconductor and $2r_C$ is the intercept of the vertical axis when we plot $r(x)$ with respect to x. Because the second term on the right side of Eq. (1) is proportional to x, $r(x)$ increases with increasing x. As shown in Fig. 2, the line for the ITO electrodes has a slightly higher slope and thus a larger resistance than that for Al electrodes. This behavior probably occurred because the ITO electrode had larger lateral resistance than Al. From the plots in Fig. 2, r_c = 2.26 and 1.22 Ω were obtained for the ITO and Al electrodes, respectively. R_C is given by

$$R_C = r_c \times W \times L_t, \quad (2)$$

where L_t is the transfer length, which is half of the intercept of the horizontal axis of the straight line in Fig. 2. From Eq. (2), R_c was calculated to be 0.057 and 0.019 Ω cm^2 for the ITO and Al electrodes, respectively, in sample C.

Figure 3 summarizes the dependence of R_C on n for all the samples obtained by the method described above. R_C decreased with increasing n. The smallest R_C, 0.019 Ω·cm^2, was obtained from Al electrodes in sample C. This value is more than one order of magnitude smaller than the smallest R_C (0.35 Ω cm^2) obtained from Al/B-doped p-$BaSi_2$ (p = 4.0 × 10^{18} cm^{-3}, μ = 28 cm^{2}V^{-1}s^{-1}) [31]. We will now discuss the reason for this behavior. According to Ref. 36, the sheet resistance R_{sheet} is given by

$$R_{\text{sheet}} = R_C/L_t^2 . \quad (2)$$

For sample C, R_{sheet} is 0.40 Ω from L_t = 0.218 mm and R_C = 0.019 Ω cm^2, while R_{sheet} equals 6.79 Ω using L_t = 0.227 mm and R_C = 0.35 Ω·cm^2 for sample E. Such a large difference in R_{sheet} between samples C and E cannot be anticipated from their similar ρ values: 0.0644 and 0.0557 Ω cm, respectively, which were determined by Hall measurements. It is known that B atoms in B-doped p-$BaSi_2$ do not segregate and so are almost uniformly distributed [44]. Figure 4 shows

the depth profile of Sb atoms and secondary ions (Ba + Si) in sample C. The Sb atoms segregate toward the surface of sample C, and the Sb concentration exceeds 10^{20} cm^{-3} near the electrode. Segregation of Sb has been observed in various semiconductors such as Si, Ge, and III–V semiconductors [45-52]. Hence, *n* is actually much higher in the surface region than the *n* found from the Hall measurement ($n = 2.4 \times 10^{18}$ cm^{-3}), leading to the significant decrease in R_{sheet} and thus R_C in sample C. Owing to the segregation of Sb in $BaSi_2$, an Sb-doped n^+-$BaSi_2$ layer should be placed on the top of the $BaSi_2$ solar cell. Hence, an Sb-doped n^+-$BaSi_2$/undoped $BaSi_2$ absorber layered structure is useful for practical applications.

We next assessed the spectral response of sample F, with an Sb-doped n^+-$BaSi_2$/undoped $BaSi_2$ structure. Figure 5 shows a schematic of sample F for this purpose and the RHEED patterns obtained after the growth of each layer. Because $BaSi_2$ has a large α, short-wavelength light is absorbed near the surface, in the Sb-doped n^+-$BaSi_2$ layer. Therefore, defective n^+-$BaSi_2$ deteriorates the solar-cell performance. Figure 6 shows the θ–2θ XRD pattern, revealing *a*-axis-oriented epitaxial growth up to the 20-nm-thick Sb-doped n^+-$BaSi_2$. Figure 7 shows the *IQE* spectrum of sample F. A bias voltage of –0.1 V was applied to the top ITO electrode with respect to the back side-surface Al electrode so that the photogenerated holes in the $BaSi_2$ were extracted into the ITO electrode. The *IQE* increased sharply at wavelengths shorter than approximately 1000 nm, corresponding to the band gap of $BaSi_2$, and reached approximately 50% over a wide wavelength range even under this small bias voltage. We observed no pronounced reduction in *IQE* at short wavelengths, even when a highly Sb-doped layer was inserted. In a $BaSi_2$ homojunction solar cell, the built-in potential across the pn junction will be much higher than 0.1 V, producing larger *IQE*s. On the basis of these findings, we conclude that the Sb-doped n^+-$BaSi_2$/undoped $BaSi_2$ absorber layered structure is suitable for practical $BaSi_2$ solar cells.

4. Conclusions

We investigated the dependence of R_C on the electron concentration of Sb-doped n-$BaSi_2$ and achieved a minimum R_C of 0.019 Ω cm^2 for Al/Sb-doped n-$BaSi_2$ at $n = 2.4 \times 10^{18}$ cm^{-3}. This R_C was more than one order of magnitude smaller than the R_C obtained for Al/B-doped p-$BaSi_2$, 0.35 Ω·cm^2. We explained this significant reduction in R_C in Al/Sb-doped n-$BaSi_2$ as being due to Sb segregation, which was verified by SIMS. The concentration of Sb atoms exceeded 10^{20} cm^{-3} near the electrode, significantly decreasing R_C. We achieved an *IQE* > 50% over a wide wavelength range under a small bias voltage of 0.1 V in the n^+(20 nm)/undoped $BaSi_2$(500 nm)/n^+-Si(111) structure.

Acknowledgements

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Figure captions

Fig. 1 θ–2θ XRD and RHEED patterns observed along the Si [$1\bar{1}2$] azimuth of samples A, B, C, and D. The asterisk (*) indicates the diffraction of the Si substrate used.

Fig. 2 Sample structure for R_C measurement and the relationships between resistance and Al or ITO electrode distance for sample C, Sb-doped n-$BaSi_2$ ($n = 2.4 \times 10^{18}$ cm^{-3}).

Fig. 3 R_C as a function of electron concentration for Al/n-$BaSi_2$ and ITO/n-$BaSi_2$. The smallest R_C (0.35 Ω cm^2) obtained from Al/p-$BaSi_2$ [31] is shown for comparison.

Fig. 4 SIMS depth profile of Sb atoms and secondary ions (Ba + Si).

Fig. 5 Sample structure of sample F and RHEED patterns of each layer observed along the Si [$1\bar{1}0$] azimuth.

Fig. 6 θ–2θ XRD pattern of sample F. The asterisk (*) indicates the diffraction of the Si substrate used.

Fig. 7 *IQE* spectrum of sample F under a bias voltage of –0.1 V applied to the surface ITO electrode with respect to the back side-surface Al electrode.

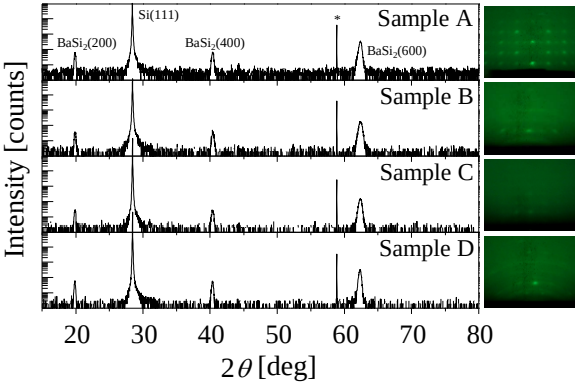
Si(111)
*
BaSi2(200)
BaSi2(400)
BaSi2(600)
Sample A
Sample B
Sample C
Sample D
Intensity [counts]
20
30
40
50
60
70
80
2θ [deg]

Fig. 1

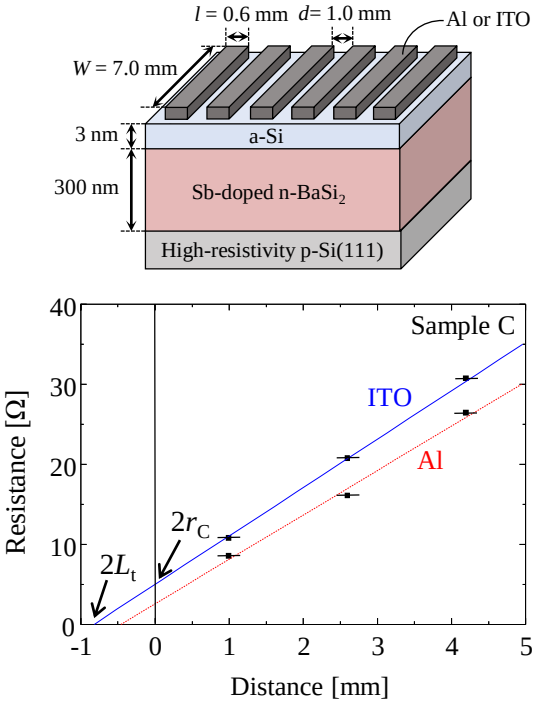
l = 0.6 mm
d= 1.0 mm
Al or ITO
W = 7.0 mm
3 nm
a-Si
300 nm
Sb-doped n-BaSi2
High-resistivity p-Si(111)
Sample C
ITO
Al
2rC
2Lt
Resistance [Ω]
Distance [mm]
0
10
20
30
40
-1
0
1
2
3
4
5

Fig. 2

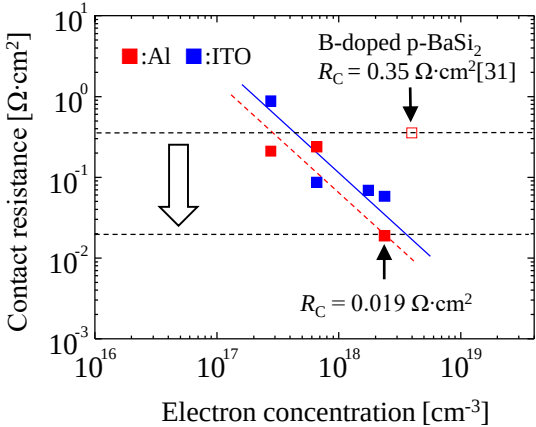
Contact resistance [Ω·cm²]
Electron concentration [cm⁻³]
■:Al ■:ITO
B-doped p-BaSi2
RC = 0.35 Ω·cm²[31]
RC = 0.019 Ω·cm²
10¹
10⁰
10⁻¹
10⁻²
10⁻³
10¹⁶
10¹⁷
10¹⁸
10¹⁹

Fig. 3

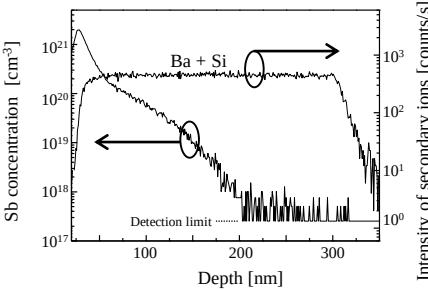
Sb concentration [cm^{-3}]
Intensity of secondary ions [counts/s]
Ba + Si
Detection limit
Depth [nm]
10^{21}
10^{20}
10^{19}
10^{18}
10^{17}
10^{3}
10^{2}
10^{1}
10^{0}
100
200
300

Fig. 4

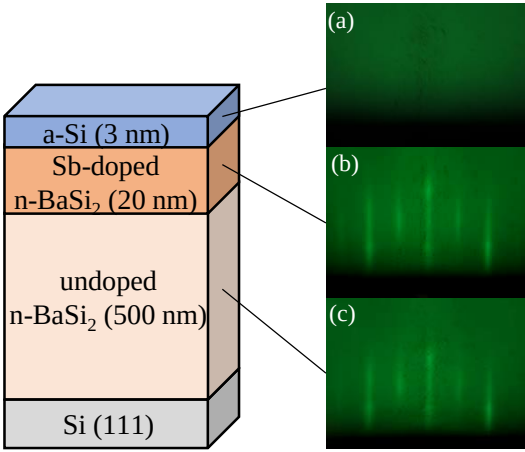

Fig. 5

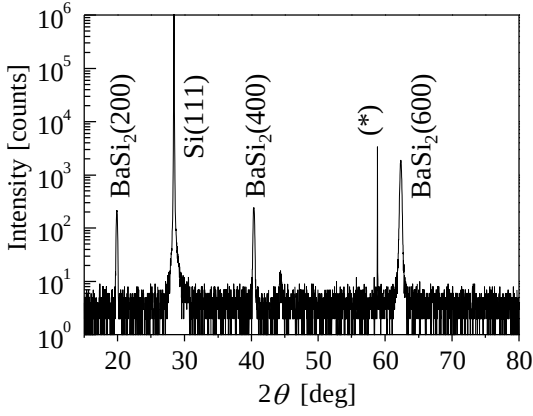
Intensity [counts]
10^6
10^5
10^4
10^3
10^2
10^1
10^0
BaSi$_2$(200)
Si(111)
BaSi$_2$(400)
(*)
BaSi$_2$(600)
20
30
40
50
60
70
80
2θ [deg]

Fig. 6

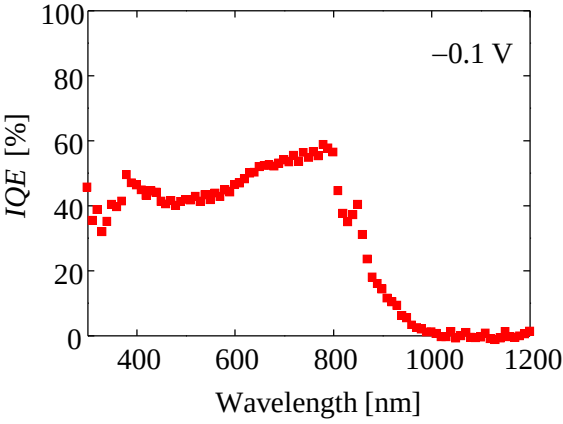

Fig. 7